



TSMC-01-660

10/083,991

January 28, 2003

2812
#7/Boyma
Updown
2/12/03
(HE)

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

Fr: George O. Saile, Reg. No. 19,572
28 Davis Ave.
Poughkeepsie, NY 12603

Subject: Serial No. 10/083,991
C. CHANG

02/26/02

"PLANARIZATION METHOD FOR DEEP SUB MICRON
SHALLOW TRENCH ISOLATION PROCESS"

Grp. Art Unit: 2812

S. ISAAC

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FEB - 7 2003
TECHNOLOGY CENTER 2800

RESPONSE PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated November 29, 2002 please consider
the following arguments:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the
United States Postal Service as first class mail in an envelope addressed to:
Commissioner of Patents and Trademarks, Washington, D.C. 20231 on
January 29, 2003.

Name Stephen B Ackerman, Reg. #37,761

Signature [Signature]

Date 1/29/03